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SMCJ-HR Series



Agency Approvals

AGENCY	AGENCY FILE NUMBER
JR.	E230531

Maximum Ratings and Thermal Characteristics (T,=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at $T_A=25^{\circ}$ C by 10/1000µs waveform (Fig.1)(Note 1), (Note 2)	P _{PPM}	1500	W
Power Dissipation on infinite heat sink at $\rm T_{A}{=}50^{o}\rm C$	P _{M(AV)}	6.5	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I _{FSM}	200	А
Maximum Instantaneous Forward Voltage at 100A for Unidirectional only (Note 4)	V _F	3.5/5.0	V
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-65 to 150	°C
Typical Thermal Resistance Junction to Lead	R _{wL}	15	°C/W
Typical Thermal Resistance Junction to Ambient	R _{uJA}	75	°C/W

Notes:

1. Non-repetitive current pulse , per Fig. 3 and derated above $\rm T_{A}$ = 25°C per Fig. 2.

2. Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal.

Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only, duty cycle=4 per minute maximum.

Functional Diagram



Description

The SMCJ-HR High Reliability series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

Features

- For surface mounted applications in order to optimize board space
- Low profile package
- Built-in strain relief
- V_{BR} @T_J= V_{BR}@25°C x (1+αT x (T_J-25))
- (*a* T:Temperature Coefficient)
- Glass passivated chip
 - junction
- 1500W peak pulse power capability at 10/1000µs waveform, repetition rate (duty cycles):0.01%
- Fast response time: typically less than 1.0ps from 0V to BV min
- Excellent clamping capability
- Low incremental surge resistance

Applications

TVS devices are ideal for the protection of I/O Interfaces, V_{cc} bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

- Typical I_R less than 1µA above 12V
- High Temperature soldering guaranteed: 260°C/40 seconds at terminals
- Plastic package has Underwriters laboratory flammability 94V-O
- Meet MSL level1, per J-STD-020, LF maximun peak of 260°C
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- 2nd level interconnect is Pb-free per IPC/JEDEC J-STD-609A.01

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Electrical Ch	aracteristics										
Part Number (Uni)	Part Number (Bi)	Mar	king	Reverse Stand off Voltage V	Volta	αdown ge V _{BR} s) @ I _T	Test Current I _T	voltage v _c	Maximum Peak Pulse Current I _{pp}	Reverse Leakage I _s	Agency Approval
		UNI	BI	(Volts)	MIN	MAX	(mA)	(V) ^{pp}	(A) ^{pp}	@ V _R	
SMCJ5.0A-HR	SMCJ5.0CA-HR	GDE	BDE	5.0	6.40	7.00	10	9.2	163.0	800	Х
SMCJ6.0A-HR	SMCJ6.0CA-HR	GDG	BDG	6.0	6.67	7.37	10	10.3	145.7	800	Х
SMCJ6.5A-HR	SMCJ6.5CA-HR	GDK	BDK	6.5	7.22	7.98	10	11.2	134.0	500	Х
SMCJ7.0A-HR	SMCJ7.0CA-HR	GDM	BDM	7.0	7.78	8.60	10	12.0	125.0	200	Х
SMCJ7.5A-HR	SMCJ7.5CA-HR	GDP	BDP	7.5	8.33	9.21	1	12.9	116.3	100	Х
SMCJ8.0A-HR	SMCJ8.0CA-HR	GDR	BDR	8.0	8.89	9.83	1	13.6	110.3	50	Х
SMCJ8.5A-HR	SMCJ8.5CA-HR	GDT	BDT	8.5	9.44	10.40	1	14.4	104.2	20	Х
SMCJ9.0A-HR	SMCJ9.0CA-HR	GDV	BDV	9.0	10.00	11.10	1	15.4	97.4	10	Х
SMCJ10A-HR	SMCJ10CA-HR	GDX	BDX	10.0	11.10	12.30	1	17.0	88.3	5	Х
SMCJ11A-HR	SMCJ11CA-HR	GDZ	BDZ	11.0	12.20	13.50	1	18.2	82.5	1	Х
SMCJ12A-HR	SMCJ12CA-HR	GEE	BEE	12.0	13.30	14.70	1	19.9	75.4	1	Х
SMCJ13A-HR	SMCJ13CA-HR	GEG	BEG	13.0	14.40	15.90	1	21.5	69.8	1	Х
SMCJ14A-HR	SMCJ14CA-HR	GEK	BEK	14.0	15.60	17.20	1	23.2	64.7	1	Х
SMCJ15A-HR	SMCJ15CA-HR	GEM	BEM	15.0	16.70	18.50	1	24.4	61.5	1	Х
SMCJ16A-HR	SMCJ16CA-HR	GEP	BEP	16.0	17.80	19.70	1	26.0	57.7	1	Х
SMCJ17A-HR	SMCJ17CA-HR	GER	BER	17.0	18.90	20.90	1	27.6	54.4	1	Х
SMCJ18A-HR	SMCJ18CA-HR	GET	BET	18.0	20.00	22.10	1	29.2	51.4	1	Х
SMCJ20A-HR	SMCJ20CA-HR	GEV	BEV	20.0	22.20	24.50	1	32.4	46.3	1	Х
SMCJ22A-HR	SMCJ22CA-HR	GEX	BEX	22.0	24.40	26.90	1	35.5	42.3	1	Х
SMCJ24A-HR	SMCJ24CA-HR	GEZ	BEZ	24.0	26.70	29.50	1	38.9	38.6	1	Х
SMCJ26A-HR	SMCJ26CA-HR	GFE	BFE	26.0	28.90	31.90	1	42.1	35.7	1	Х
SMCJ28A-HR	SMCJ28CA-HR	GFG	BFG	28.0	31.10	34.40	1	45.4	33.1	1	Х
SMCJ30A-HR	SMCJ30CA-HR	GFK	BFK	30.0	33.30	36.80	1	48.4	31.0	1	Х
SMCJ33A-HR	SMCJ33CA-HR	GFM	BFM	33.0	36.70	40.60	1	53.3	28.2	1	Х
SMCJ36A-HR	SMCJ36CA-HR	GFP	BFP	36.0	40.00	44.20	1	58.1	25.9	1	Х
SMCJ40A-HR	SMCJ40CA-HR	GFR	BFR	40.0	44.40	49.10	1	64.5	23.3	1	Х
SMCJ43A-HR	SMCJ43CA-HR	GFT	BFT	43.0	47.80	52.80	1	69.4	21.7	1	Х
SMCJ45A-HR	SMCJ45CA-HR	GFV	BFV	45.0	50.00	55.30	1	72.7	20.6	1	Х
SMCJ48A-HR	SMCJ48CA-HR	GFX	BFX	48.0	53.30	58.90	1	77.4	19.4	1	Х
SMCJ51A-HR	SMCJ51CA-HR	GFZ	BFZ	51.0	56.70	62.70	1	82.4	18.2	1	Х
SMCJ54A-HR	SMCJ54CA-HR	GGE	BGE	54.0	60.00	66.30	1	87.1	17.3	1	Х
SMCJ58A-HR	SMCJ58CA-HR	GGG	BGG	58.0	64.40	71.20	1	93.6	16.1	1	Х
SMCJ60A-HR	SMCJ60CA-HR	GGK	BGK	60.0	66.70	73.70	1	96.8	15.5	1	Х
SMCJ64A-HR	SMCJ64CA-HR	GGM	BGM	64.0	71.10	78.60	1	103.0	14.6	1	Х
SMCJ70A-HR	SMCJ70CA-HR	GGP	BGP	70.0	77.80	86.00	1	113.0	13.3	1	Х
SMCJ75A-HR	SMCJ75CA-HR	GGR	BGR	75.0	83.30	92.10	1	121.0	12.4	1	Х
SMCJ78A-HR	SMCJ78CA-HR	GGT	BGT	78.0	86.70	95.80	1	126.0	11.9	1	Х
SMCJ85A-HR	SMCJ85CA-HR	GGV	BGV	85.0	94.40	104.00	1	137.0	11.0	1	Х
SMCJ90A-HR	SMCJ90CA-HR	GGX	BGX	90.0	100.00	111.00	1	146.0	10.3	1	Х
SMCJ100A-HR	SMCJ100CA-HR	GGZ	BGZ	100.0	111.00	123.00	1	162.0	9.3	1	Х
SMCJ110A-HR	SMCJ110CA-HR	GHE	BHE	110.0	122.00	135.00	1	177.0	8.5	1	Х
SMCJ120A-HR	SMCJ120CA-HR	GHG	BHG	120.0	133.00	147.00	1	193.0	7.8	1	Х
SMCJ130A-HR	SMCJ130CA-HR	GHK	ВНК	130.0	144.00	159.00	1	209.0	7.2	1	Х
SMCJ150A-HR	SMCJ150CA-HR	GHM	BHM	150.0	167.00	185.00	1	243.0	6.2	1	Х
SMCJ160A-HR	SMCJ160CA-HR	GHP	BHP	160.0	178.00	197.00	1	259.0	5.8	1	Х
SMCJ170A-HR	SMCJ170CA-HR	GHR	BHR	170.0	189.00	209.00	1	275.0	5.5	1	Х

Note:

1. For bidirectional type having $V_{\rm B}$ of 10 volts and less, the I_{\rm B} limit is double.

2. 100% High Temperature Storage Life test and Reflow Simulation.

3. 100% HTRB(High Temperature Reverse Bias). For Unidirectional, 150C/100%VR/96hours,

for Bidirectional, 150C/100%VR/192hrs(96hours for each direction for Bidirectional).

4. Each lot of parts will pass group B test requirement.

Transient Voltage Suppression Diodes Surface Mount – 1500W > SMCJ-HR Series



Screen Process

100% vision inspection	MIL-STD-750 method 2074
100%High Temperature Storage Life (168hrs,150C)	MIL-STD-750 method 1031
100% X-RAY inspection	MIL-STD-750 method 2076
100% Temperature cycle test (-55-150C, 20 cycles, dwell time 15 min)	MIL-STD-750 method 1051
100% Reflow (2X)	JEDEC J-STD-020
100% surge test (2x)	MIL-STD-750 method 4066
100% HTRB(150C, Bias=VR(80% breakdown voltage), 96hrs),for Bi- direction products, 96hrs for each direction	MIL–STD–750 method 1038
Final electrical test(100% 3 sigma limit, 100% dynamic test and PAT limit)	MIL-STD-750 method 4016.4021.4011

Note: Up-screen program can be specified by customer's request via contacting Littlefuse service

Group B Test Requirement

Screen	Method	Condition	Requirement
Surge test	10/1000 µs Peak Pluse Waveform	Maximum Clamping Voltage (V _c) @ Peak Plus Current (I _{pp})	Sample size 45 perform 10x Accept 0 failures
Burn - In (HTRB)	MIL-STD-750, Method 1038.5	Applied Voltage 100% V _R @150°C	Sample size 45 340 hours (680 hours for bi-direction products, each direction 340 hours) Accept 0 failures
Electrical test	-	I _R @V _R , V(_{BR})@I _T	Sample size 45 Accept 0 failures

I-V Curve Characteristics





 $\mathbf{P}_{_{\text{PPM}}}$ Peak Pulse Power Dissipation – Max power dissipation

 $\mathbf{V}_{_{\!R}}$ $\,$ Stand-off Voltage – Maximum voltage that can be applied to the TVS without operation

 $V_{_{BR}}$ Breakdown Voltage – Maximum voltagethat flows though the TVS at a specified test current (I,)

V. Clamping Voltage - Peak voltage measured across the suppressor at a specified lppm (peak impulse current)

 ${\boldsymbol I}_{_{\! R}}$ Reverse Leakage Current -- Current measured at $V_{_{\! R}}$

 $V_{\scriptscriptstyle F}$ $\,$ Forward Voltage Drop for Uni-directional $\,$



Ratings and Characteristic Curves (T₄=25°C unless otherwise noted)



Figure 3 - Pulse Derating Curve



Figure 5 - Typical Junction Capacitance



Figure 2 - Peak Pulse Power Rating



Figure 4 - Pulse Waveform







Transient Voltage Suppression Diodes Surface Mount – 1500W > SMCJ-HR Series







Soldering Parameters

Reflow Co	ndition	Lead–free assembly
	-Temperature Min (T _{s(min)})	150°C
Pre Heat	-Temperature Max (T _{s(max)})	200°C
	-Time (min to max) (t _s)	60 – 180 secs
Average ra (T _L) to pea	amp up rate (LiquidusTemp k	3°C/second max
$T_{S(max)}$ to T_{L}	- Ramp-up Rate	3°C/second max
Reflow	-Temperature (T_L) (Liquidus)	217°C
nellow	-Time (min to max) (t _s)	60 – 150 seconds
PeakTemp	perature (T _P)	260 ^{+0/-5} °C
Time with Temperatu	in 5°C of actual peak ure (t _p)	20 – 40 seconds
Ramp-dov	vn Rate	6°C/second max
Time 25°C	to peakTemperature (T _P)	8 minutes Max.
Do not exc	ceed	280°C

Physical Specifications

Weight	0.007 ounce, 0.21 grams
Case	JEDEC DO214AB. Molded plastic body over glass passivated junction
Polarity	Color band denotes positive end (cathode) except Bidirectional.
Terminal	Matte Tin-plated leads, Solderable per JESD22-B102



Environmental Specifications

High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Thermal Shock	JESD22-A106
MSL	JEDEC-J-STD-020, Level 1
H3TRB	JESD22-A101
RSH	JESD22-B106



Dimensions



Dimensions	Inc	hes	Millimeters		
Dimensions	Min	Max	Min	Max	
А	0.114	0.126	2.900	3.200	
В	0.260	0.280	6.600	7.110	
С	0.220	0.245	5.590	6.220	
D	0.079	0.103	2.060	2.620	
E	0.030	0.060	0.760	1.520	
F	0.002	0.008	0.051	0.203	
G	0.305	0.320	7.750	8.130	
Н	0.006	0.012	0.152	0.305	
I	0.129	-	3.300	-	
J	0.094	-	2.400	-	
K	-	0.165	-	4.200	
L	0.094	-	2.400	-	

Part Marking System



Packaging

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMCJxxxXX-HR	DO-214AB	500	Tape & Reel – 16mm tape/7" reel	EIA STD RS-481

Tape and Reel Specification

Part Numbering System



